Claims

Please amend the claims as follows:

Claims 1-16 (Canceled)

17. (Original) An enclosure comprising:

a hollow substantially cylindrical insulating core having a first orifice having a first diameter and at least one further orifice, the first orifice constructed and arranged for coupling the interior of the insulating core to a temperature controlled air source and a second orifice constructed and arranged for allowing air entering the core through the first orifice to pass over a test fixture substantially enclosed within the core prior to exiting through the further orifice, the hollow substantially cylindrical insulating core being partially coated with a conductive material maintained at a reference potential relative to the test fixture.

- (Original) The enclosure of claim 17, wherein the hollow substantially cylindrical insulating core comprises fiberglass.
- 19. (Original) The enclosure of claim 17, wherein the first diameter is about 4.5 inches.
- 20. (Original) The enclosure of claim 17, wherein the conductive material comprises a semiconductor.
- 21. (Original) The enclosure of claim 17, wherein the conductive material comprises a metal.
- 22. (Original) The enclosure of claim 21, wherein the metal comprises copper.
- 23. (Original) The enclosure of claim 17, wherein the enclosure has at least two uncoated chamfered edges.
- 24. (Original) A method of fabricating an enclosure, the method comprising: forming a cylindrically shaped block of insulating material having a substantially flat first end, a substantially flat second end, and an outer surface;

forming a first hole having a first diameter in the cylindrically shaped block to form a first inner surface:

forming a second hole having a second diameter in the cylindrically shaped block to form a second inner surface, the second diameter being greater than the first diameter; and

coating the outer surface, the substantially flat first end, the first inner surface, and the second inner surface with a conductive material.

- 25. (Original) The method of claim 24, wherein coating the outer surface, the first end, the first inner surface, and the second inner surface with a conductive material comprises:
- coating the outer surface, the first end, the first inner surface and the second inner surface with aluminum.
- 26. (Original) The method of claim 25, wherein coating the outer surface, the first end, the first inner surface and the second inner surface with aluminum comprises:
- depositing the aluminum on the outer surface, the first end, the first inner surface and the second inner surface by chemical vapor deposition.
- 27. (Original) The method of claim 24, wherein coating the outer surface, the first end, the first inner surface, and the second inner surface with a conductive material comprises:
- coating the outer surface, the first end, the first inner surface and the second inner surface with a semiconductor.
- 28. (Original) The method of claim 27, wherein coating the outer surface, the first end, the first inner surface and the second inner surface with a semiconductor comprises:
- painting the semiconductor on the outer surface, the first end, the first inner surface and the second inner surface.
- 29. (Original) The method of claim 27, wherein coating the outer surface, the first end, the first inner surface and the second inner surface with a semiconductor comprises:
- spraying the semiconductor on the outer surface, the first end, the first inner surface and the second inner surface.